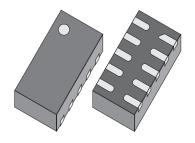
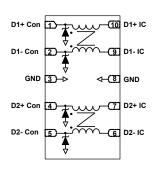


Common mode filter with ESD protection for high speed serial interface



QFN-10L 2.6 x 1.35 x 0.5



Product status link

ECMF04-4HSWM10

Product summary				
Order code	ECMF04-4HSWM10			

Features

- Very large differential bandwidth to comply with HDMI Full HD, MIPI, USB2.0, USB3.2 Gen 1, Display Port and other high speed serial interfaces
- High common mode attenuation on WLAN frequencies:
 - 28 dB at 2.4 GHz and -16 dB at 5.0 GHz
- · Very good attenuation at LTE, GSM and GPS frequencies
- · Large bandwidth: 4.2 GHz
- Low PCB space consumption
- Thin package for compact applications: 0.55 mm max.
- · High reduction of parasitic elements through integration
- RoHS package

Exceed the following standards

- IEC 61000-4-2, level 4:
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)

Applications

- · Mobile phones
- Notebook, laptop
- · Portable devices
- PND

Description

The ECMF04-4HSWM10 is a highly integrated common mode filter designed to suppress EMI/RFI common mode noise on high speed differential serial buses like HDMI Full HD, MIPI, Display Port and other high speed serial interfaces.

The device has a very large differential bandwidth to comply with these standards and can protect and filter two differential lanes.



1 Characteristics

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Symbol	Parameter	Value	Unit		
		IEC 61000-4-2:		kV	
V _{PP}	Peak pulse voltage	Contact discharge	8		
		Air discharge	16		
I _{RMS}	Maximum RMS current	100	mA		
T _{op}	Operating ambient temperature rang	-55 to +125			
T _j	Maximum junction temperature	125	°C		
T _{stg}	Storage temperature range	-55 to +150			

Figure 1. Electrical characteristics (definitions)

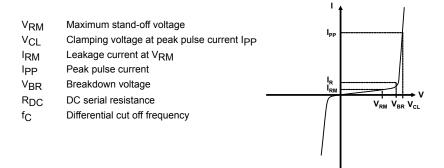


Table 2. Electrical characteristics (T_{amb} = 25 °C)

Symbol	Test conditions		Тур.	Max.	Unit
V _{BR}	I _R = 1 mA		5.5		V
I _{RM}	V _{RM} = 3 V per line			100	nA
R _{DC}	DC serial resistance		5		Ω
f _C	-3 dB differential mode cut-off frequency		4.2		GHz

Table 3. Pin description

Pin number	Description Pin number		Description
1	D1+ to connector	6	D2- to IC
2	D1- to connector	7	D2+ to IC
3	GND	8	GND
4	D2+ to connector	9	D1- to IC
5	D2- to connector	10	D1+ to IC

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1.1 Characteristics (curves)

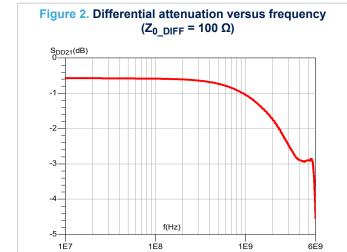
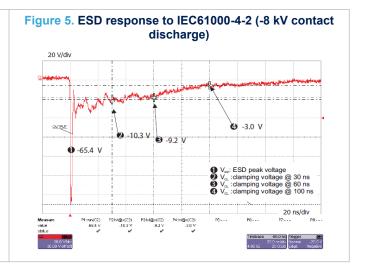
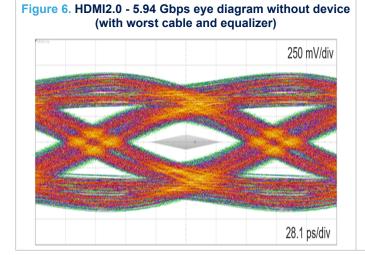
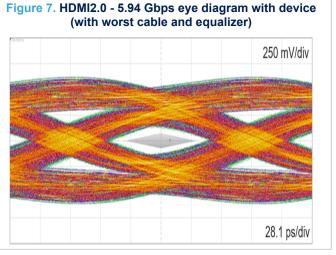


Figure 3. Common mode attenuation versus frequency $(Z_{0_COM} = 50 \ \Omega)$







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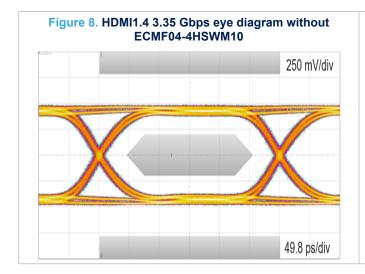


Figure 9. HDMI1.4 3.35 Gbps eye diagram with ECMF04-4HSWM10

250 mV/div

49.8 ps/div

Figure 10. USB3.2 Gen 1 5.0 Gbps eye diagram without ECMF04-4HSWM10 (with worst cable and equalizer)

100 mV/div

33.3 ps/div

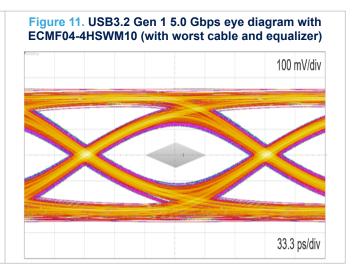
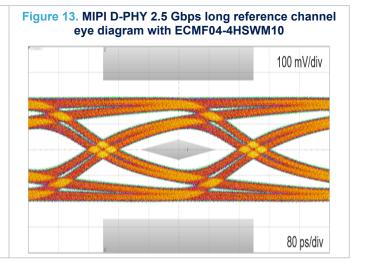


Figure 12. MIPI D-PHY 2.5 Gbps long reference channel eye diagram without ECMF04-4HSWM10

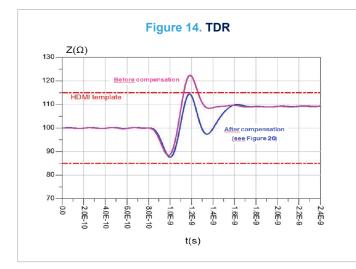
100 mV/div

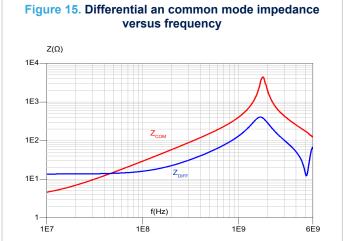
80 ps/div



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2 Application information

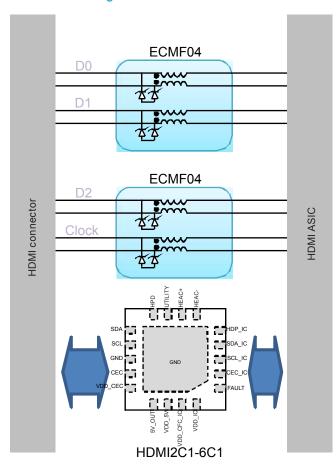


Figure 16. HDMI schematic

More application information available in following AN:

- AN4356: "Antenna desense on handheld equipment"
- AN4511: "Common mode filters"
- AN4540: "MHL link filtering and protection"

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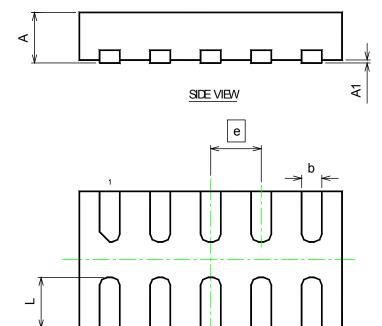
3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Figure 17. QFN10L package outline

3.1 QFN-10L package information

TOP VIEW



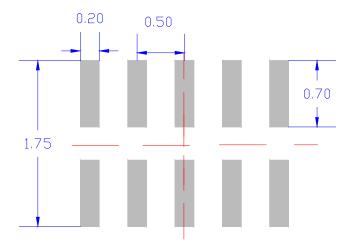
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Table 4. QFN10L package mechanical data

	Dimensions			
Ref.	Millimeters			
	Min.	Тур.	Max.	
А	0.45	0.50	0.55	
A1	0.00	0.02	0.05	
b	0.15	0.20	0.25	
D	2.55	2.60	2.65	
E	1.30	1.35	1.40	
е		0.50		
L	0.40	0.50	0.60	

Figure 18. Footprint recommendations (mm)



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4 PCB assembly recommendation

Figure 19. Recommended PCB layout

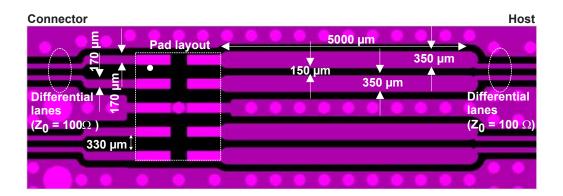
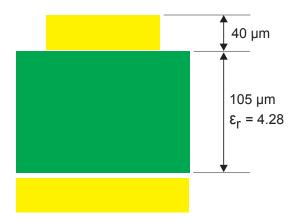


Figure 20. PCB stack dimensions



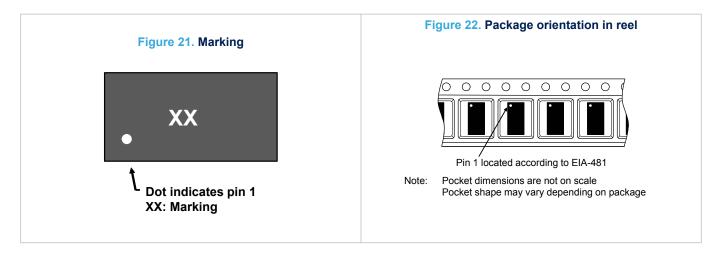
4.1 Solder paste

- 1. Halide-free flux qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste is recommended.
- 3. Offers a high tack force to resist component movement during high speed.
- 4. Use solder paste with fine particles: powder particle size is 20-38 μm.

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4.2 QFN-10L packing information



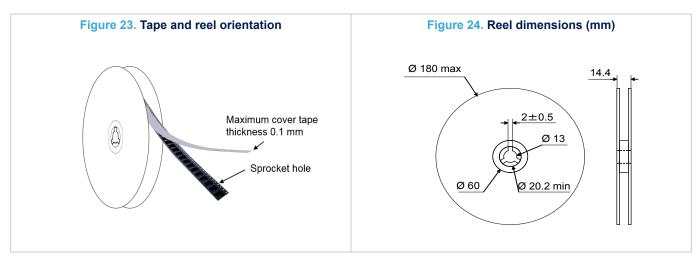
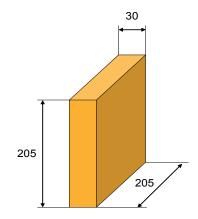


Figure 25. Inner box dimensions (mm)



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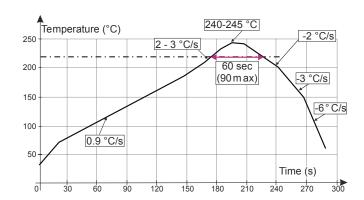


Dot identifying Pin A1 location 2.0±0.05 4.0±0.1 0.20±0.05 4.0±0.1 0.20±0.05 4.0±0.1 0.65±0.05 4.0 User direction of unreeling

Figure 26. Tape and reel outline

4.3 Solder reflow





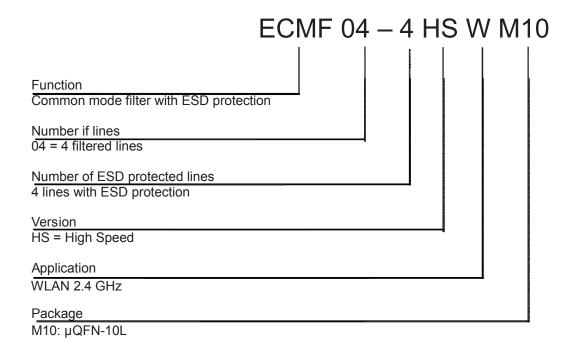
Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

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5 Ordering information

Figure 28. Ordering information scheme



Order code	Marking	Package	Weight	Base qty.	Delivery mode
ECMF04-4HSWM10	KW ⁽¹⁾	μQFN-10L	5 mg	3000	Tape and reel

^{1.} The marking can be rotated by 90° to differentiate assembly location

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Revision history

Table 5. Document revision history

Date	Version	Changes	
10-Jun-2014	1	Initial release.	
08-Jan-2018	2	Updated Table 1.	
16-Mar-2021 3	2	Updated Figure 8 and Figure 9.	
	3	Added Figure 10, Figure 11 and Figure 15.	

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P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD101-B1-02ELS E6327 ESD112-B1-02EL E6327
ESD119B1W01005E6327XTSA1 ESD5V0J4-TP ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF
3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7
SCM1293A-04SO ESD200-B1-CSP0201 E6327 ESD203-B1-02EL E6327 SM12-7 SMF8.0A-TP SMLJ45CA-TP CEN955 W/DATA
82350120560 82356240030 VESD12A1A-HD1-GS08 CPDUR5V0R-HF CPDUR24V-HF CPDQC5V0U-HF CPDQC5V0USP-HF
CPDQC5V0-HF D1213A-01LP4-7B D1213A-02WL-7 ESDLIN1524BJ-HQ 5KP100A